

Voltage Regulator - Dual, Low I_Q , Low Dropout, Dual Input

300 mA

NCP154

The NCP154 is 300 mA, Dual Output Linear Voltage Regulator that offers two independent input pins and provides a very stable and accurate voltage with ultra low noise and very high Power Supply Rejection Ratio (PSRR) suitable for RF applications. The device doesn't require any additional noise bypass capacitor to achieve ultra low noise performance. In order to optimize performance for battery operated portable applications, the NCP154 employs the Adaptive Ground Current Feature for low ground current consumption during light-load conditions.

Features

- Operating Input Voltage Range: 1.9 V to 5.25 V
- Two Independent Input Voltage Pins
- Two Independent Output Voltage (for detail please refer to Ordering Information)
- Low I_Q of typ. 55 μ A per Channel
- High PSRR: 75 dB at 1 kHz
- Very Low Dropout: 140 mV Typical at 300 mA
- Thermal Shutdown and Current Limit Protections
- Stable with a 1 μ F Ceramic Output Capacitor
- Available in XDFN8 1.2 $\times$ 1.6 mm Package
- Active Output Discharge for Fast Output Turn-Off
- These are Pb-free Devices

Typical Applications

- Smartphones, Tablets
- Wireless Handsets, Wireless LAN, Bluetooth[®], ZigBee[®] Interfaces
- Other Battery Powered Applications

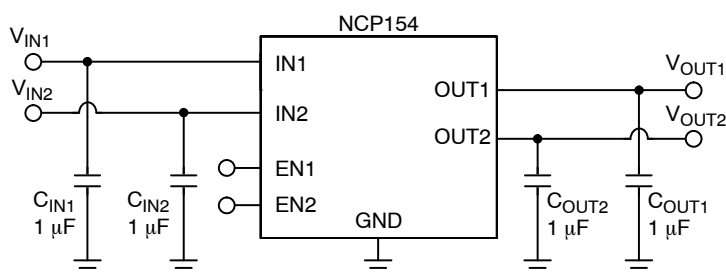
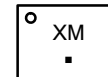


Figure 1. Typical Application Schematic



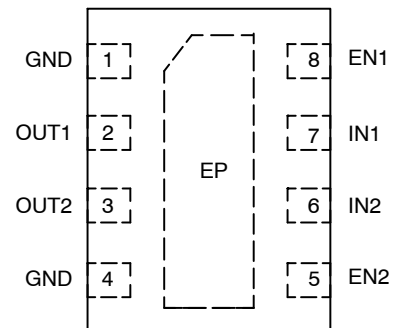
XDFN8, 1.2x1.6
CASE 711AS

MARKING DIAGRAM



X = Specific Device Code
M = Date Code
■ = Pb-Free Package

PIN CONNECTIONS



XDFN8
(Top View)

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 17 of this data sheet.

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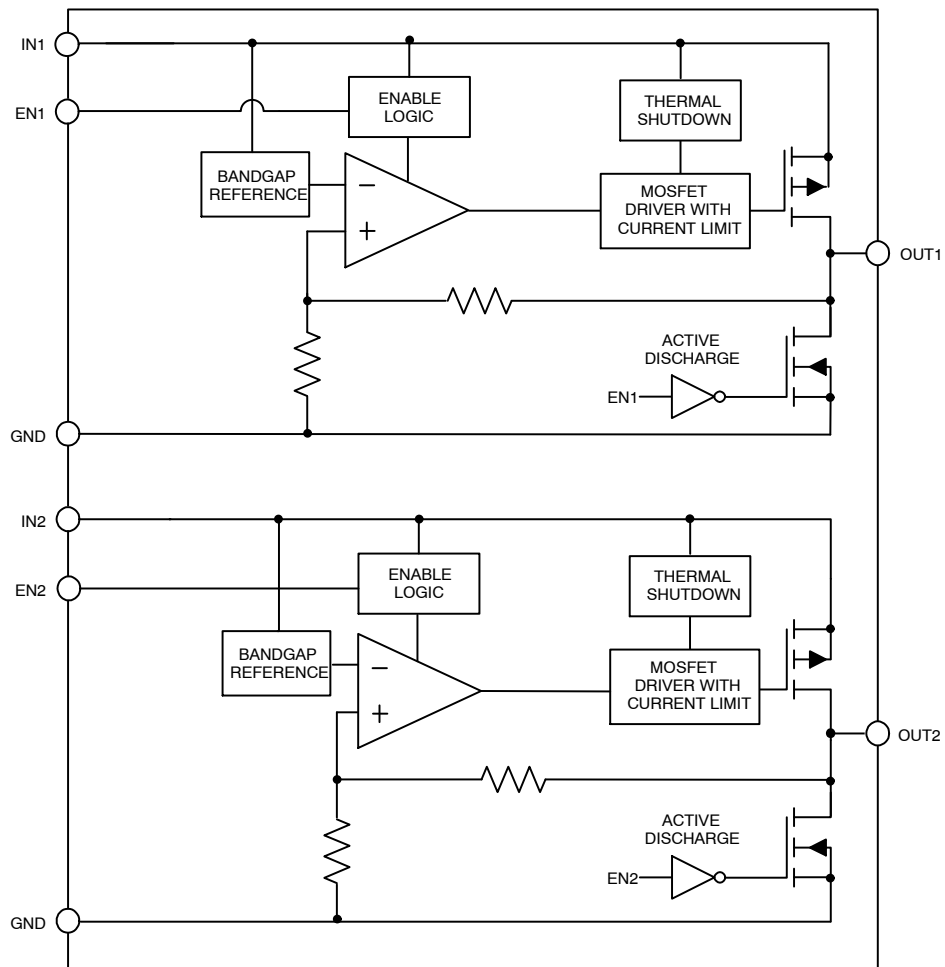


Figure 2. Simplified Schematic Block Diagram

Table 1. PIN FUNCTION DESCRIPTION

Pin No.	Pin Name	Description
1	GND	Power supply ground. Soldered to the copper plane allows for effective heat dissipation.
2	OUT1	Regulated output voltage of the first channel. A small 1 μ F ceramic capacitor is needed from this pin to ground to assure stability.
3	OUT2	Regulated output voltage of the second channel. A small 1 μ F ceramic capacitor is needed from this pin to ground to assure stability.
4	GND	Power supply ground. Soldered to the copper plane allows for effective heat dissipation.
5	EN2	Driving EN2 over 0.9 V turns-on OUT2. Driving EN below 0.4 V turns-off the OUT2 and activates the active discharge.
6	IN2	Inputs pin for second channel. It is recommended to connect 1 μ F ceramic capacitor close to the device pin.
7	IN1	Inputs pin for first channel. It is recommended to connect 1 μ F ceramic capacitor close to the device pin.
8	EN1	Driving EN1 over 0.9 V turns-on OUT1. Driving EN below 0.4 V turns-off the OUT1 and activates the active discharge.
–	EP	Exposed pad must be tied to ground. Soldered to the copper plane allows for effective thermal dissipation.

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Table 2. ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input Voltage (Note 1)	V_{IN1}, V_{IN2}	-0.3 V to 6 V	V
Output Voltage	V_{OUT1}, V_{OUT2}	-0.3 V to $V_{IN} + 0.3$ V or 6 V	V
Enable Inputs	V_{EN1}, V_{EN2}	-0.3 V to $V_{IN} + 0.3$ V or 6 V	V
Output Short Circuit Duration	t_{SC}	Indefinite	s
Maximum Junction Temperature	$T_{J(MAX)}$	150	°C
Storage Temperature	T_{STG}	-55 to 150	°C
ESD Capability, Human Body Model (Note 2)	ESD_{HBM}	2,000	V
ESD Capability, Machine Model (Note 2)	ESD_{MM}	200	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.
2. This device series incorporates ESD protection and is tested by the following methods:
 ESD Human Body Model tested per AEC-Q100-002 (EIA/JESD22-A114)
 ESD Machine Model tested per AEC-Q100-003 (EIA/JESD22-A115)
 Latchup Current Maximum Rating tested per JEDEC standard: JESD78.

Table 3. THERMAL CHARACTERISTICS (Note 3)

Rating	Symbol	Value	Unit
Thermal Characteristics, XDFN8 1.2 × 1.6 mm, Thermal Resistance, Junction-to-Air	θ_{JA}	160	°C/W

3. Single component mounted on 1 oz, FR4 PCB with 645 mm² Cu area.

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Table 4. ELECTRICAL CHARACTERISTICS

($-40^{\circ}\text{C} \leq T_J \leq 85^{\circ}\text{C}$; $V_{IN} = V_{OUT(NOM)} + 1\text{ V}$ or 2.5 V , whichever is greater; $V_{EN} = 0.9\text{ V}$, $I_{OUT} = 1\text{ mA}$, $C_{IN} = C_{OUT} = 1\text{ }\mu\text{F}$. Typical values are at $T_J = +25^{\circ}\text{C}$. Min/Max values are specified for $T_J = -40^{\circ}\text{C}$ and $T_J = 85^{\circ}\text{C}$ respectively.) (Note 4)

Parameter	Test Conditions		Symbol	Min	Typ	Max	Unit
Operating Input Voltage			V_{IN}	1.9		5.25	V
Output Voltage Accuracy	$-40^{\circ}\text{C} \leq T_J \leq 85^{\circ}\text{C}$	$V_{OUT} > 2\text{ V}$	V_{OUT}	-2		+2	%
		$V_{OUT} \leq 2\text{ V}$		-60		+60	mV
Line Regulation	$V_{OUT} + 0.5\text{ V} \leq V_{IN} \leq 5\text{ V}$		Reg_{LINE}		0.02	0.1	%/V
Load Regulation	$I_{OUT} = 1\text{ mA}$ to 300 mA		Reg_{LOAD}		15	40	mV
Dropout Voltage (Note 5)	$I_{OUT} = 300\text{ mA}$	$V_{OUT(nom)} = 1.5\text{ V}$	V_{DO}		360	470	mV
		$V_{OUT(nom)} = 1.8\text{ V}$			335	390	mV
		$V_{OUT(nom)} = 2.7\text{ V}$			165	275	mV
		$V_{OUT(nom)} = 2.8\text{ V}$			160	270	mV
		$V_{OUT(nom)} = 3.0\text{ V}$			150	260	mV
		$V_{OUT(nom)} = 3.3\text{ V}$			140	250	mV
Output Current Limit	$V_{OUT} = 90\% V_{OUT(nom)}$		I_{CL}		400		mA
Quiescent Current	$I_{OUT} = 0\text{ mA}$, $\text{EN}1 = V_{IN}$, $\text{EN}2 = 0\text{V}$ or $\text{EN}2 = V_{IN}$, $\text{EN}1 = 0\text{V}$		I_Q		55	100	μA
	$I_{OUT1} = I_{OUT2} = 0\text{ mA}$, $V_{\text{EN}1} = V_{\text{EN}2} = V_{IN}$		I_Q		110	200	μA
Shutdown current (Note 6)	$V_{EN} \leq 0.4\text{ V}$, $V_{IN} = 5.25\text{ V}$		I_{DIS}		0.1	1	μA
EN Pin Threshold Voltage							
High Threshold	V_{EN} Voltage increasing		V_{EN_HI}	0.9			V
Low Threshold	V_{EN} Voltage decreasing		V_{EN_LO}			0.4	
EN Pin Input Current	$V_{EN} = V_{IN} = 5.25\text{ V}$		I_{EN}		0.3	1.0	μA
Power Supply Rejection Ratio	$V_{IN} = V_{OUT} + 1\text{ V}$ for $V_{OUT} > 2\text{ V}$, $V_{IN} = 2.5\text{ V}$, for $V_{OUT} \leq 2\text{ V}$, $I_{OUT} = 10\text{ mA}$	$f = 1\text{ kHz}$	PSRR		75		dB
Output Noise Voltage	$f = 10\text{ Hz}$ to 100 kHz		V_N		75		μV_{rms}
Active Discharge Resistance	$V_{IN} = 4\text{ V}$, $V_{EN} < 0.4\text{ V}$		R_{DIS}		50		Ω
Thermal Shutdown Temperature	Temperature increasing from $T_J = +25^{\circ}\text{C}$		T_{SD}		160		$^{\circ}\text{C}$
Thermal Shutdown Hysteresis	Temperature falling from T_{SD}		T_{SDH}	-	20	-	$^{\circ}\text{C}$

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- Performance guaranteed over the indicated operating temperature range by design and/or characterization. Production tested at $T_J = T_A = 25^{\circ}\text{C}$. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
- Characterized when V_{OUT} falls 100 mV below the regulated voltage at $V_{IN} = V_{OUT(NOM)} + 1\text{ V}$.
- Shutdown Current is the current flowing into the IN pin when the device is in the disable state.

TYPICAL CHARACTERISTICS

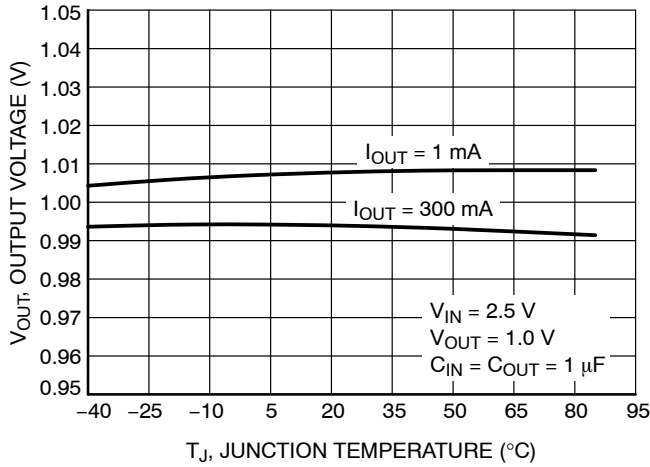


Figure 3. Output Voltage vs. Temperature – $V_{OUT} = 1.0\text{ V}$

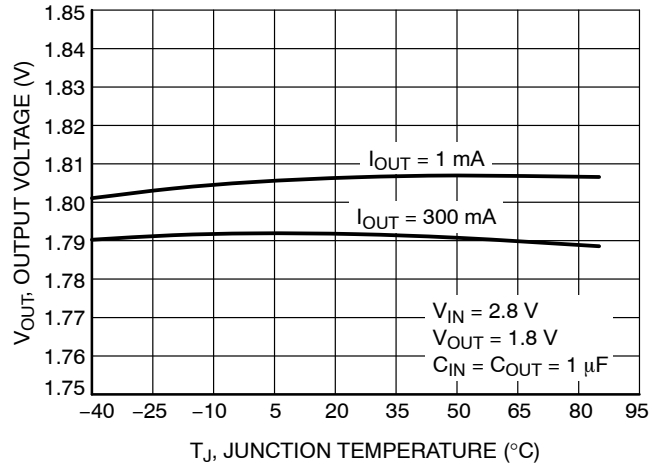


Figure 4. Output Voltage vs. Temperature – $V_{OUT} = 1.8\text{ V}$

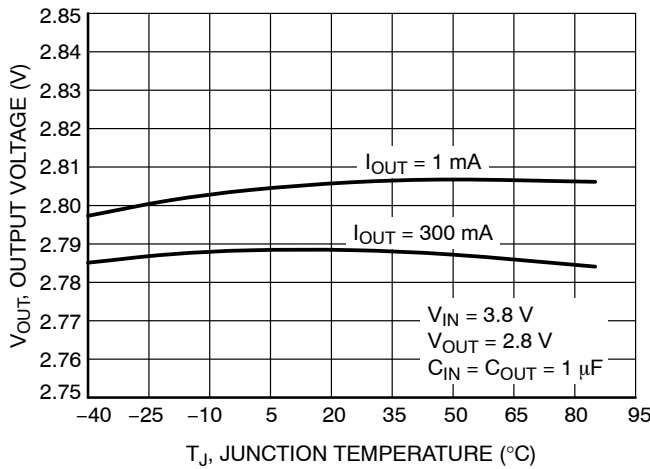


Figure 5. Output Voltage vs. Temperature – $V_{OUT} = 2.8\text{ V}$

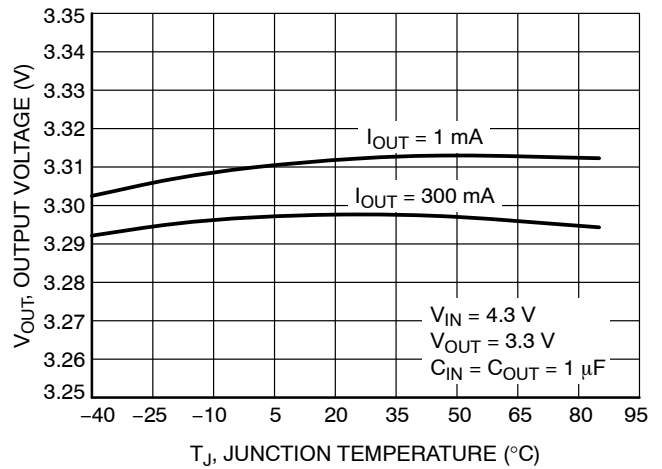


Figure 6. Output Voltage vs. Temperature – $V_{OUT} = 3.3\text{ V}$

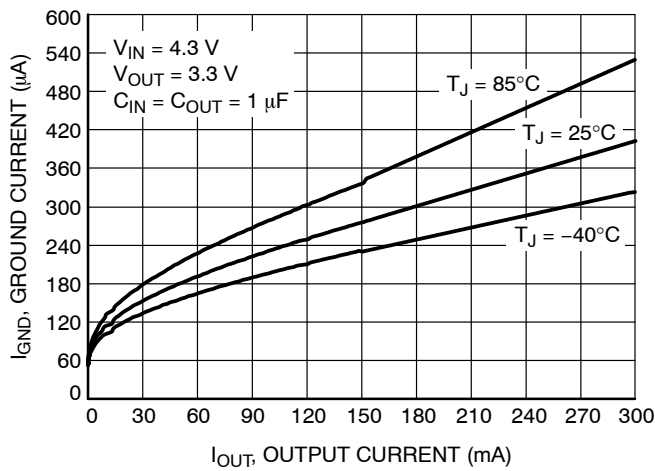


Figure 7. Ground Current vs. Output Current

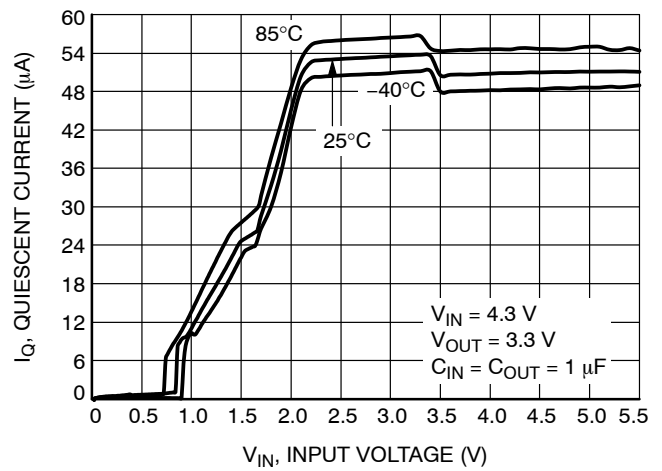


Figure 8. Quiescent Current vs. Input Voltage

TYPICAL CHARACTERISTICS

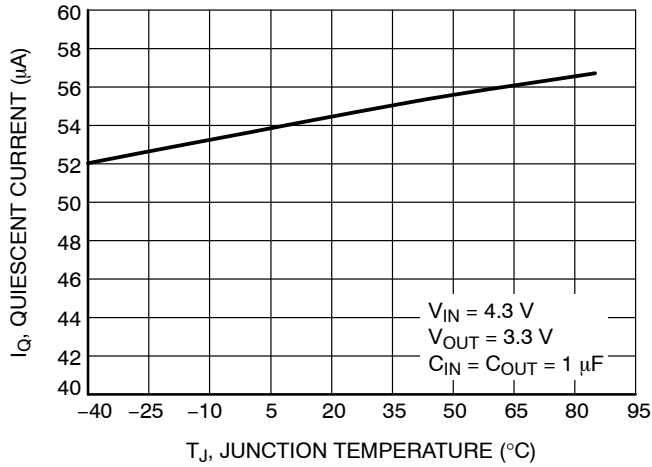


Figure 9. Quiescent Current vs. Temperature

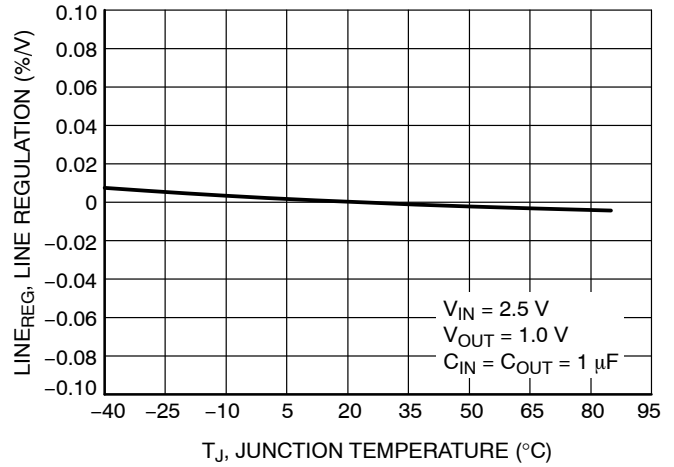


Figure 10. Line Regulation vs. Temperature – $V_{OUT} = 1.0 V$

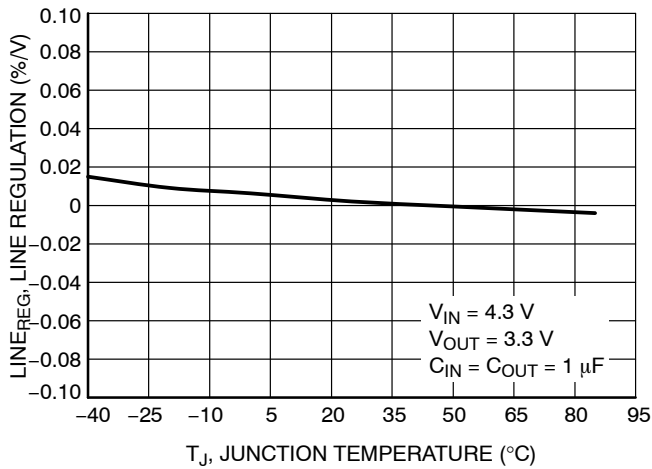


Figure 11. Line Regulation vs. Temperature – $V_{OUT} = 3.3 V$

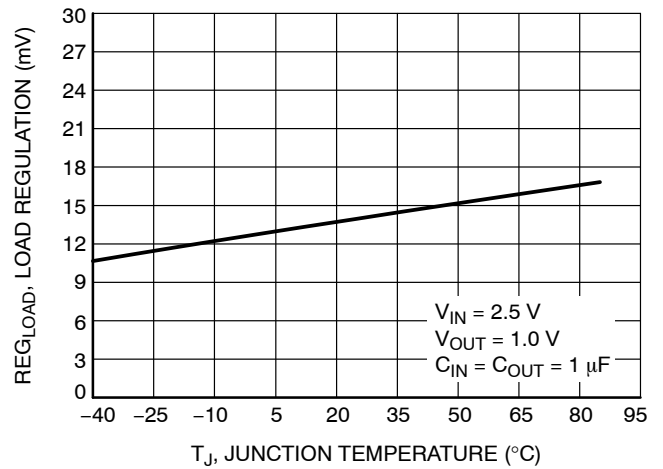


Figure 12. Load Regulation vs. Temperature – $V_{OUT} = 1.0 V$

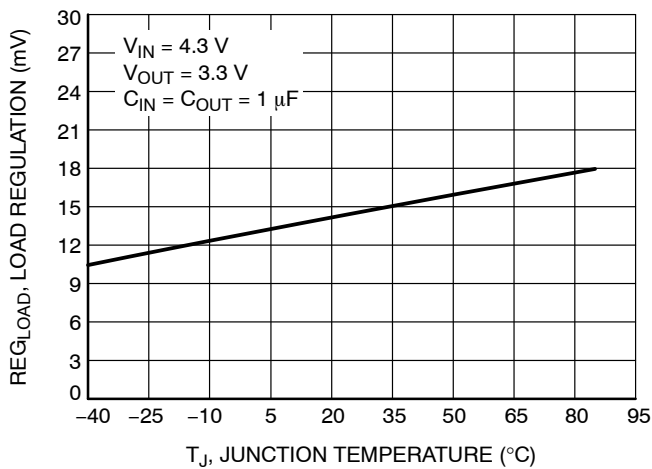


Figure 13. Load Regulation vs. Temperature – $V_{OUT} = 3.3 V$

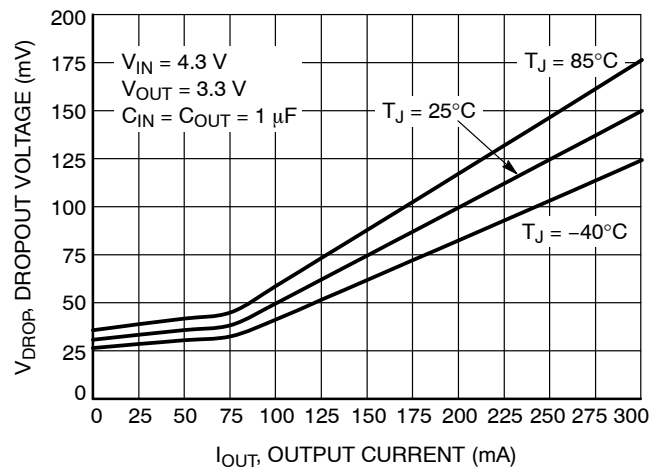


Figure 14. Dropout Voltage vs. Output Current – $V_{OUT} = 3.3 V$

TYPICAL CHARACTERISTICS

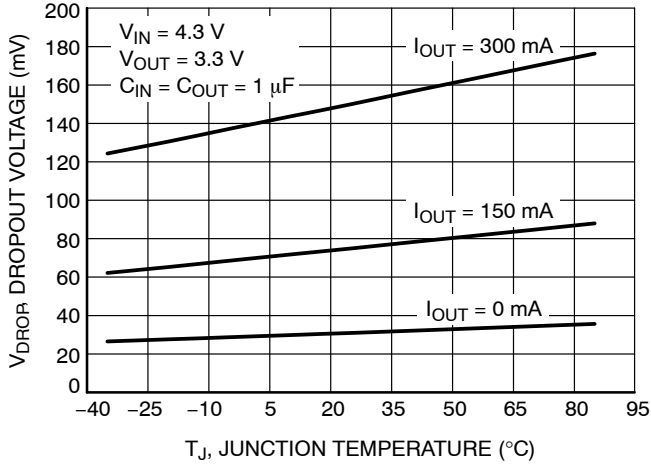


Figure 15. Dropout Voltage vs. Temperature

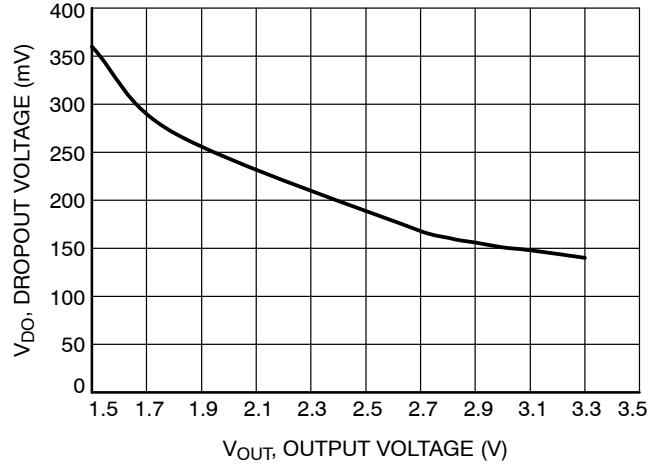


Figure 16. Dropout Voltage vs. Output Voltage

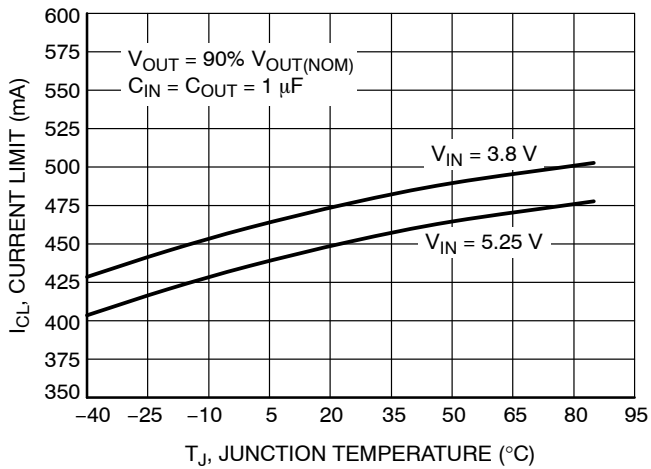


Figure 17. Current Limit vs. Temperature

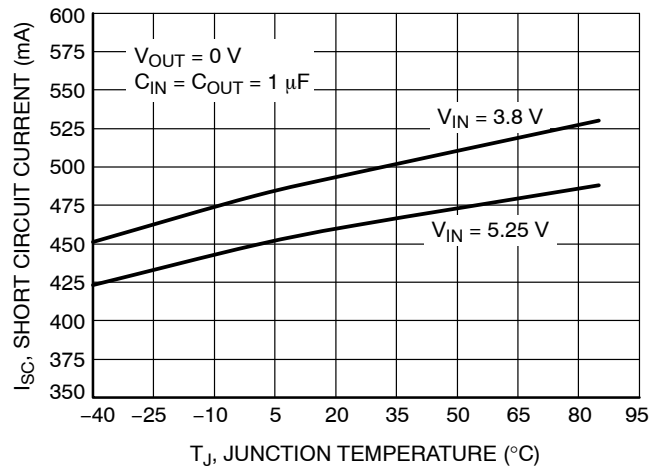


Figure 18. Short Circuit Current vs. Temperature

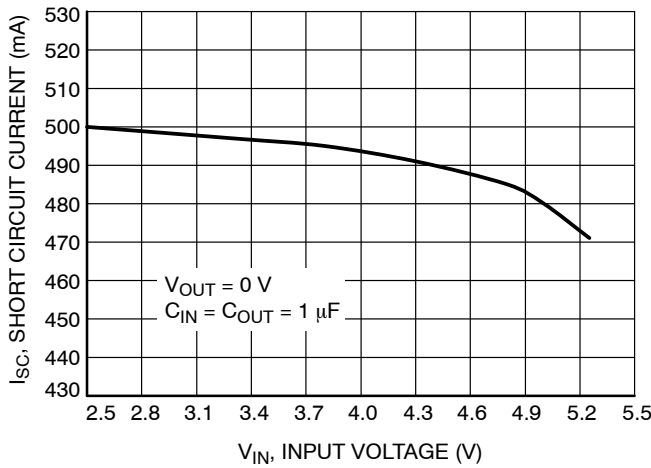


Figure 19. Short Circuit Current vs. Input Voltage

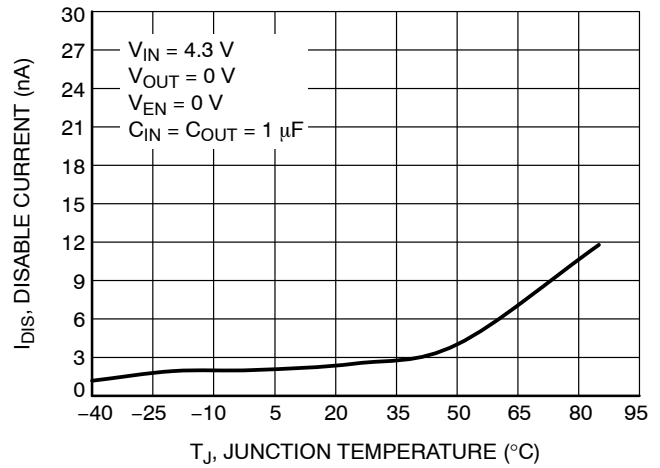


Figure 20. Disable Current vs. Temperature

TYPICAL CHARACTERISTICS

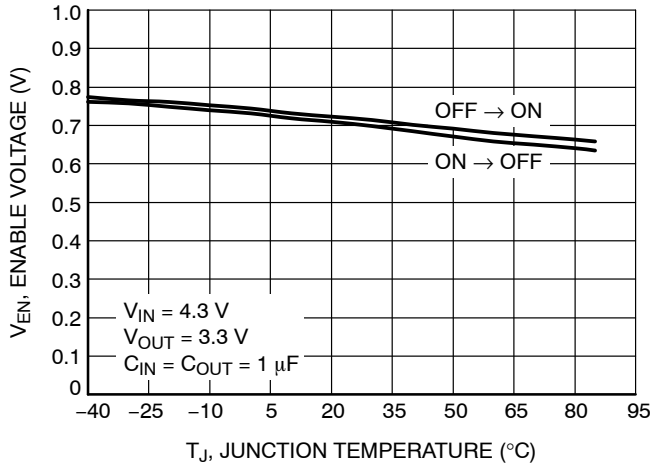


Figure 21. Enable Thresholds vs. Temperature

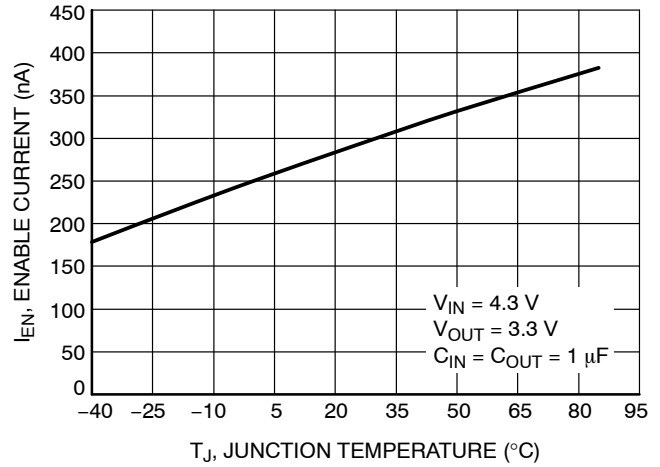


Figure 22. Current to Enable Pin vs. Temperature

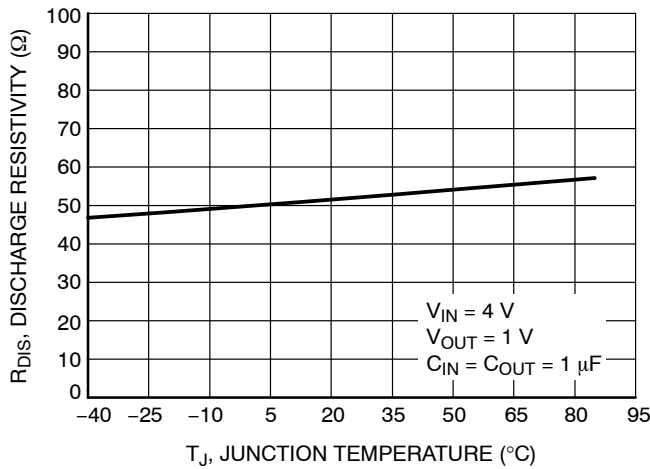


Figure 23. Discharge Resistivity vs. Temperature

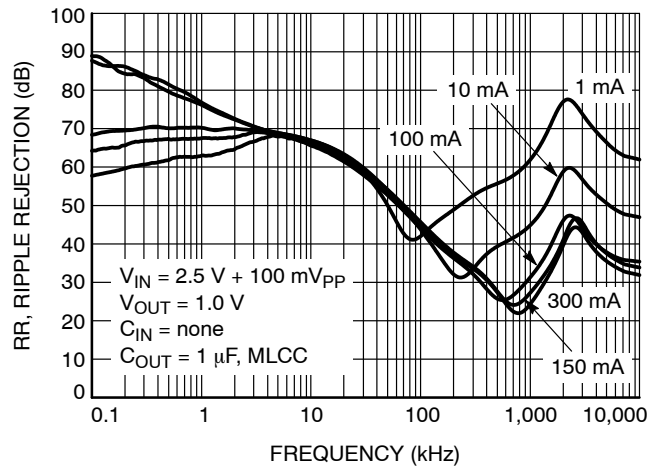


Figure 24. Power Supply Rejection Ratio, $V_{OUT} = 1.0 V$

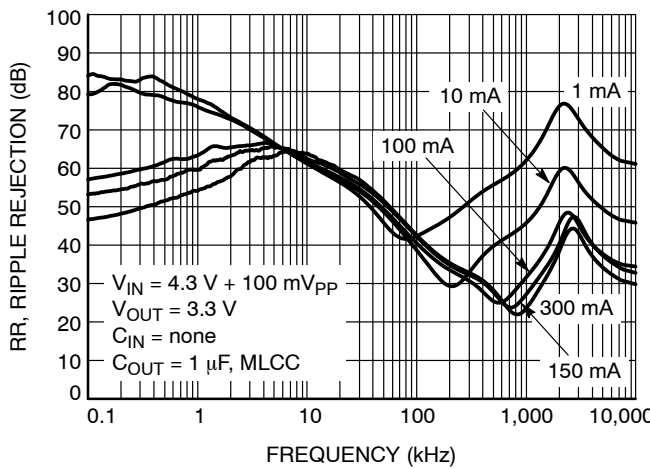


Figure 25. Power Supply Rejection Ratio, $V_{OUT} = 3.3 V$

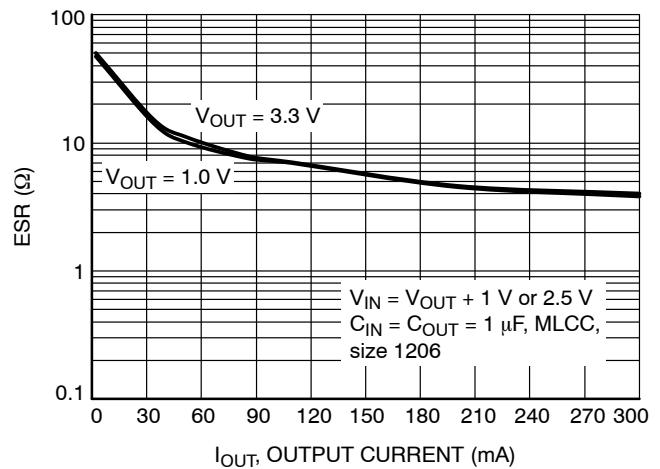
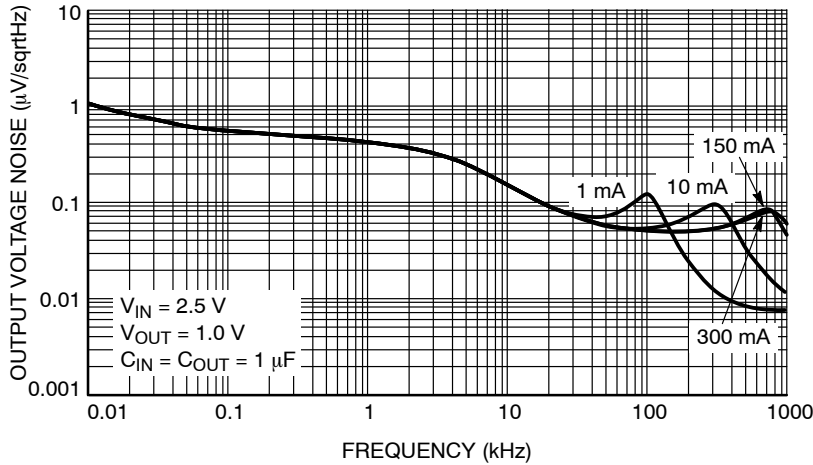


Figure 26. Output Capacitor ESR vs. Output Current

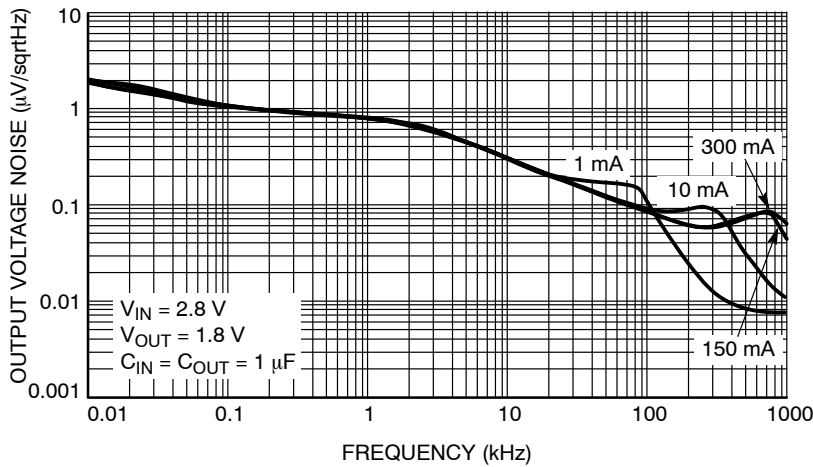
NCP154

TYPICAL CHARACTERISTICS



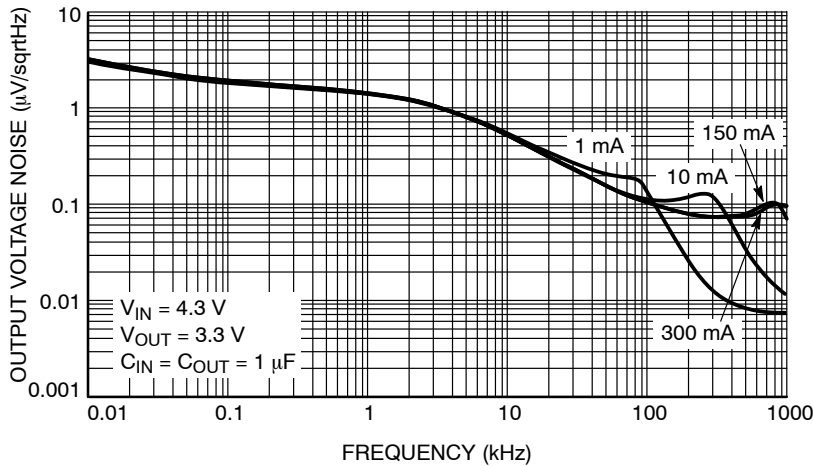
I _{OUT}	RMS Output Noise (μV)	
	10 Hz – 100 kHz	100 Hz – 100 kHz
1 mA	40.83	40.27
10 mA	36.03	35.38
150 mA	36.54	35.97
300 mA	37.05	36.48

Figure 27. Output Voltage Noise Spectral Density for V_{OUT} = 1.0 V, C_{OUT} = 1 μF



I _{OUT}	RMS Output Noise (μV)	
	10 Hz – 100 kHz	100 Hz – 100 kHz
1 mA	77.84	77.28
10 mA	71.71	70.48
150 mA	71.95	70.88
300 mA	72.71	71.67

Figure 28. Output Voltage Noise Spectral Density for V_{OUT} = 1.8 V, C_{OUT} = 1 μF



I _{OUT}	RMS Output Noise (μV)	
	10 Hz – 100 kHz	100 Hz – 100 kHz
1 mA	119.7	117.87
10 mA	113.47	111.47
150 mA	113.84	112.05
300 mA	115.95	114.03

Figure 29. Output Voltage Noise Spectral Density for V_{OUT} = 3.3 V, C_{OUT} = 1 μF

TYPICAL CHARACTERISTICS

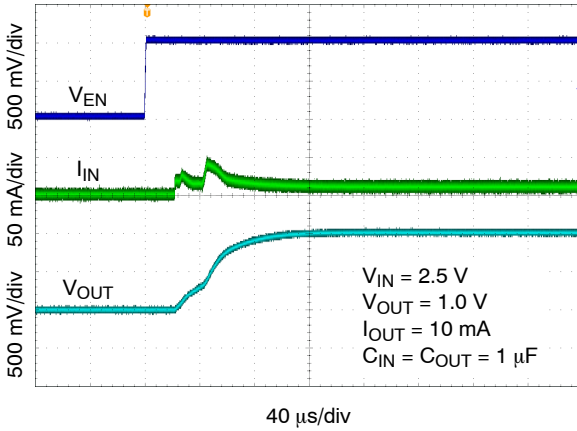


Figure 30. Enable Turn-on Response –
 $V_{OUT} = 1.0\text{ V}$, $C_{OUT} = 1\text{ }\mu\text{F}$

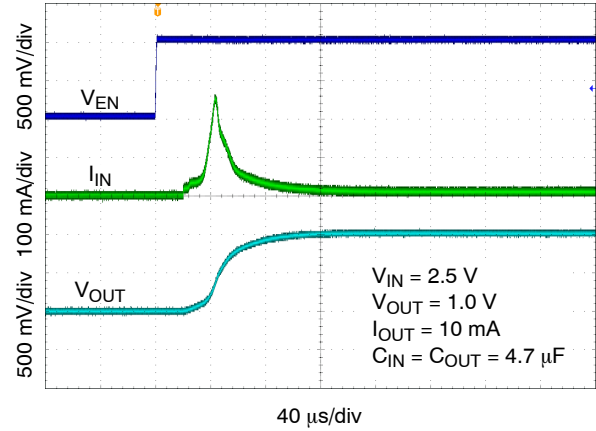


Figure 31. Enable Turn-on Response –
 $V_{OUT} = 1.0\text{ V}$, $C_{OUT} = 4.7\text{ }\mu\text{F}$

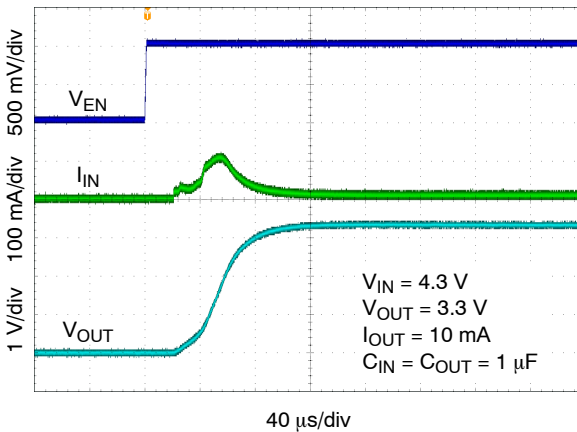


Figure 32. Enable Turn-on Response –
 $V_{OUT} = 3.3\text{ V}$, $C_{OUT} = 1\text{ }\mu\text{F}$

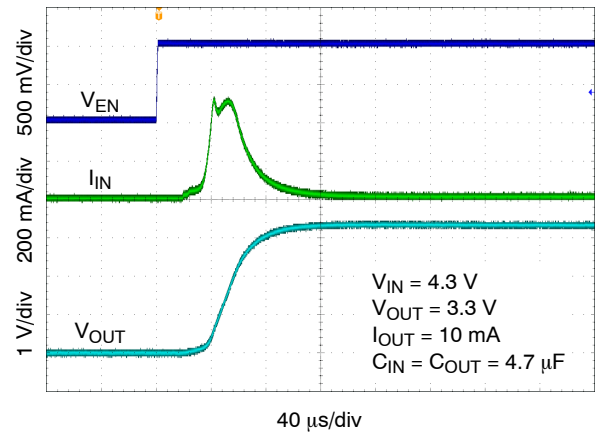


Figure 33. Enable Turn-on Response –
 $V_{OUT} = 3.3\text{ V}$, $C_{OUT} = 4.7\text{ }\mu\text{F}$

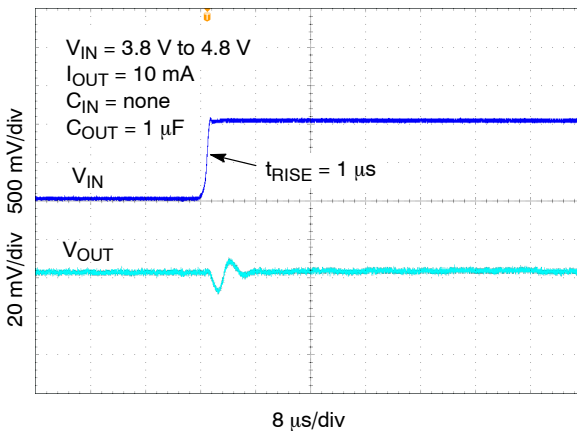


Figure 34. Line Transient Response – Rising
Edge, $V_{OUT} = 3.3\text{ V}$, $I_{OUT} = 10\text{ mA}$

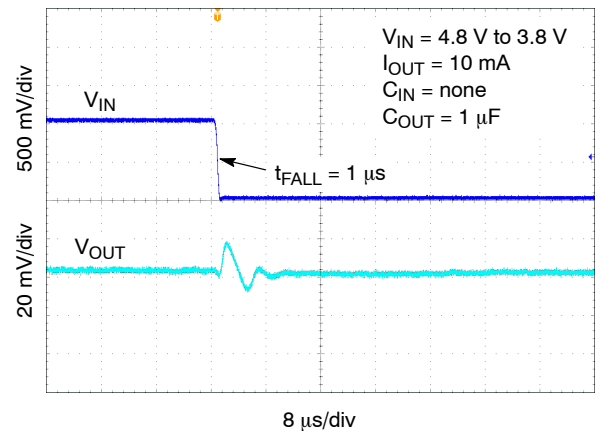


Figure 35. Line Transient Response – Falling
Edge, $V_{OUT} = 3.3\text{ V}$, $I_{OUT} = 10\text{ mA}$

TYPICAL CHARACTERISTICS

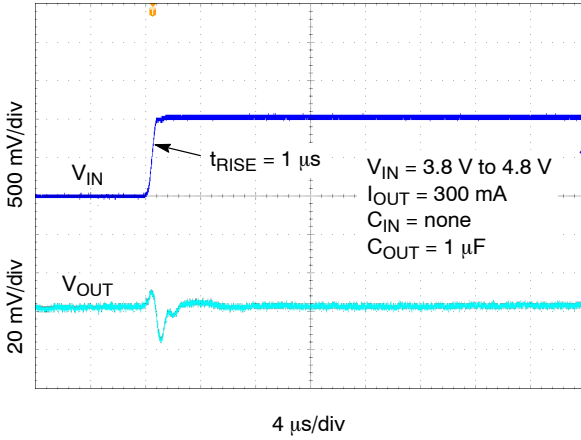


Figure 36. Line Transient Response– Rising Edge, $V_{OUT} = 3.3 \text{ V}$, $I_{OUT} = 300 \text{ mA}$

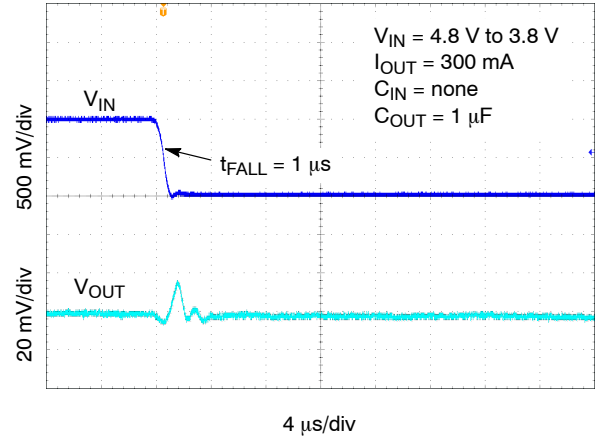


Figure 37. Line Transient Response– Falling Edge, $V_{OUT} = 3.3 \text{ V}$, $I_{OUT} = 300 \text{ mA}$

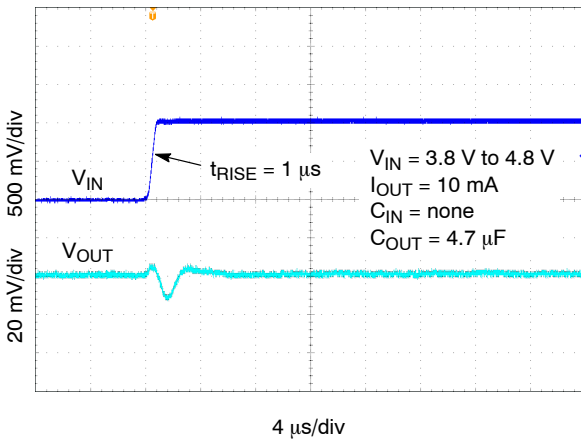


Figure 38. Line Transient Response– Rising Edge, $V_{OUT} = 3.3 \text{ V}$, $I_{OUT} = 10 \text{ mA}$, $C_{OUT} = 4.7 \mu\text{F}$

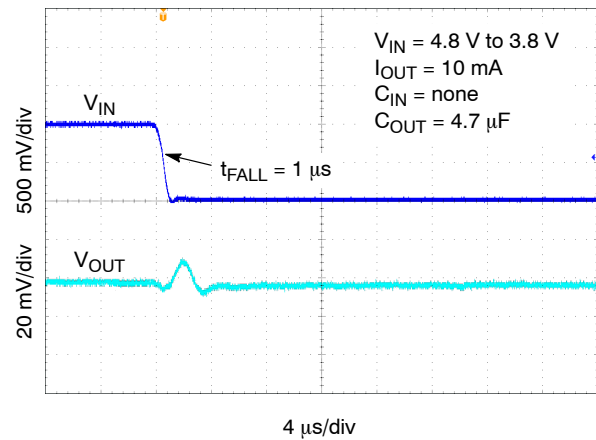


Figure 39. Line Transient Response– Falling Edge, $V_{OUT} = 3.3 \text{ V}$, $I_{OUT} = 10 \text{ mA}$, $C_{OUT} = 4.7 \mu\text{F}$

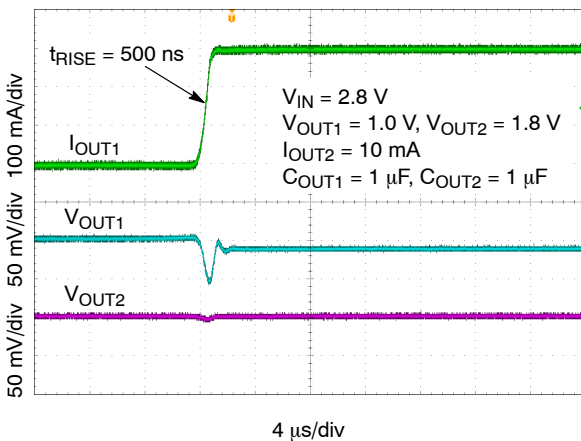


Figure 40. Load Transient Response – 1.0 V – Rising Edge, $I_{OUT1} = 100 \mu\text{A}$ to 300 mA

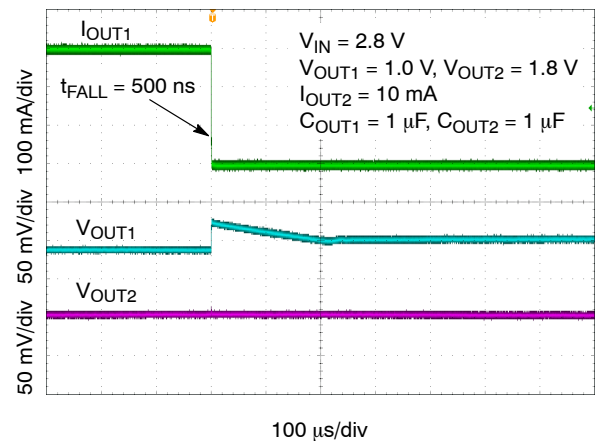


Figure 41. Load Transient Response – 1.0 V – Falling Edge, $I_{OUT1} = 300 \text{ mA}$ to $100 \mu\text{A}$

TYPICAL CHARACTERISTICS

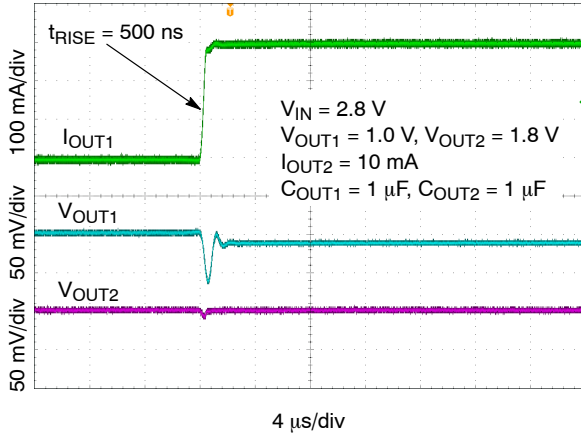


Figure 42. Load Transient Response – 1.0 V – Rising Edge, $I_{OUT1} = 1\text{ mA}$ to 300 mA

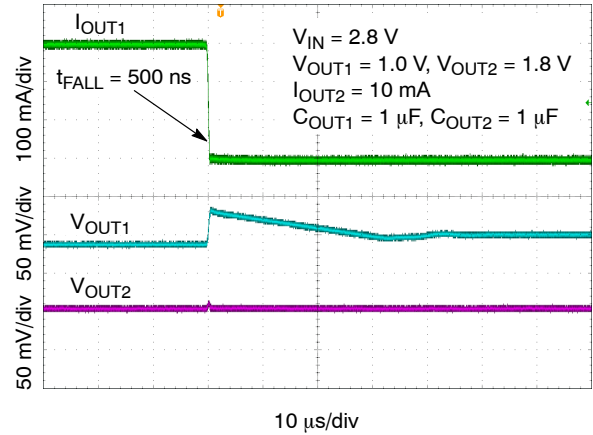


Figure 43. Load Transient Response – 1.0 V – Falling Edge, $I_{OUT1} = 300\text{ mA}$ to 1 mA

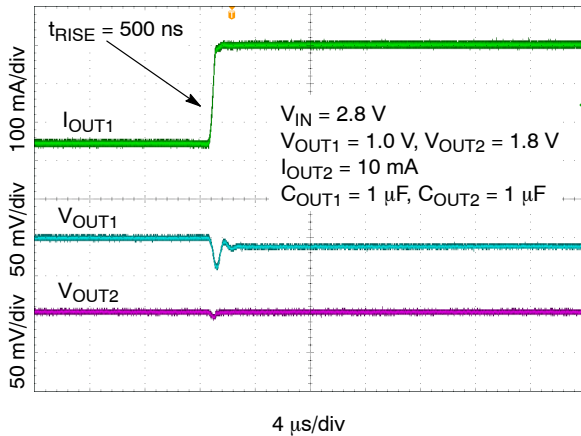


Figure 44. Load Transient Response – 1.0 V – Rising Edge, $I_{OUT1} = 50\text{ mA}$ to 300 mA

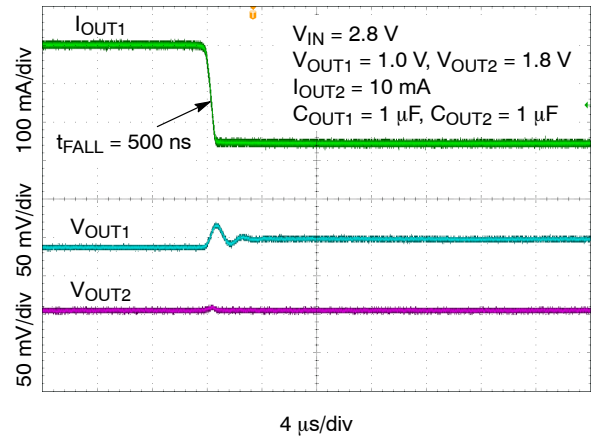


Figure 45. Load Transient Response – 1.0 V – Falling Edge, $I_{OUT1} = 300\text{ mA}$ to 50 mA

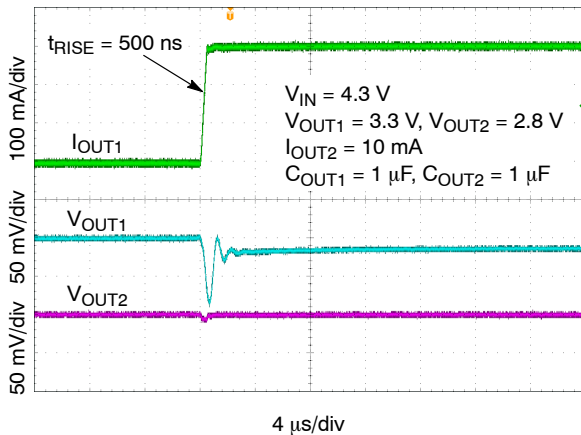


Figure 46. Load Transient Response – 3.3 V – Rising Edge, $I_{OUT1} = 100\text{ }\mu\text{A}$ to 300 mA

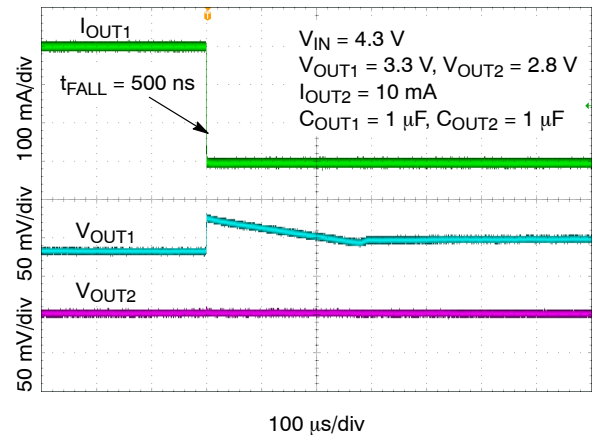


Figure 47. Load Transient Response – 3.3 V – Falling Edge, $I_{OUT1} = 300\text{ mA}$ to 100 μA

TYPICAL CHARACTERISTICS

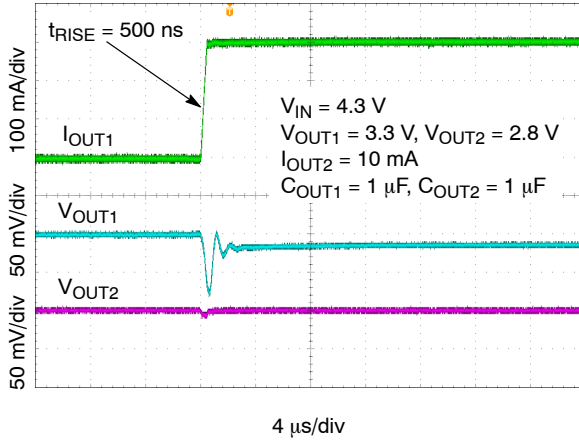


Figure 48. Load Transient Response – 3.3 V – Rising Edge, $I_{OUT1} = 1 \text{ mA}$ to 300 mA

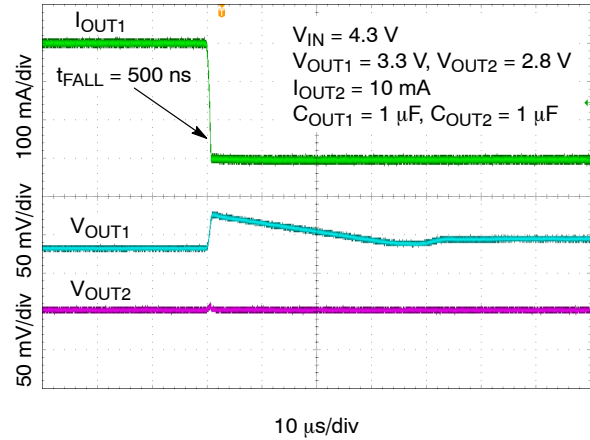


Figure 49. Load Transient Response – 3.3 V – Falling Edge, $I_{OUT1} = 300 \text{ mA}$ to 1 mA

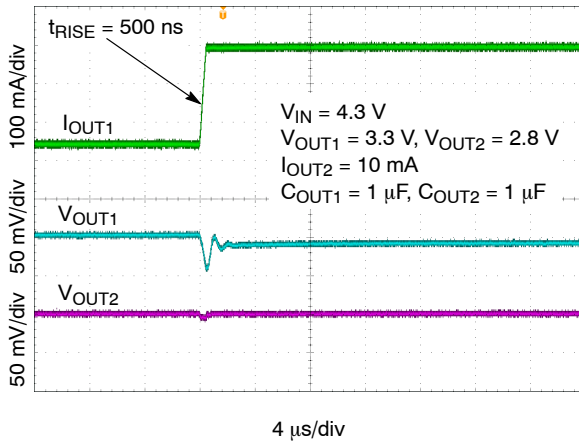


Figure 50. Load Transient Response – 3.3 V – Rising Edge, $I_{OUT1} = 50 \text{ mA}$ to 300 mA

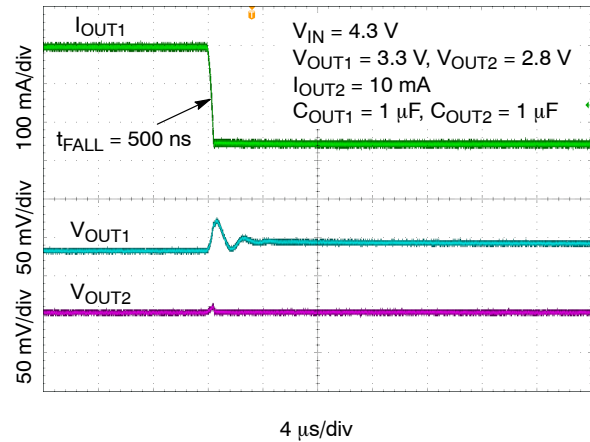


Figure 51. Load Transient Response – 3.3 V – Falling Edge, $I_{OUT1} = 300 \text{ mA}$ to 50 mA

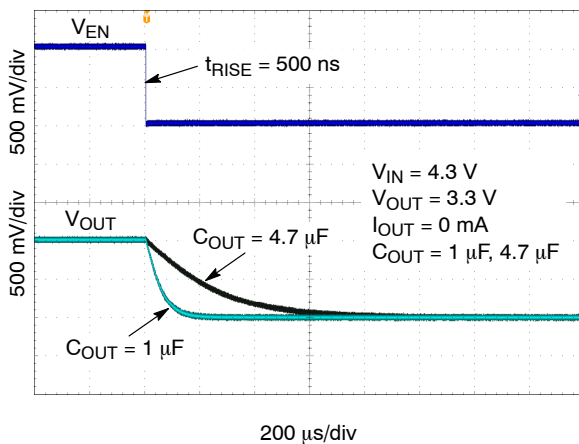


Figure 52. Enable Turn-Off – $V_{OUT} = 1.0 \text{ V}$

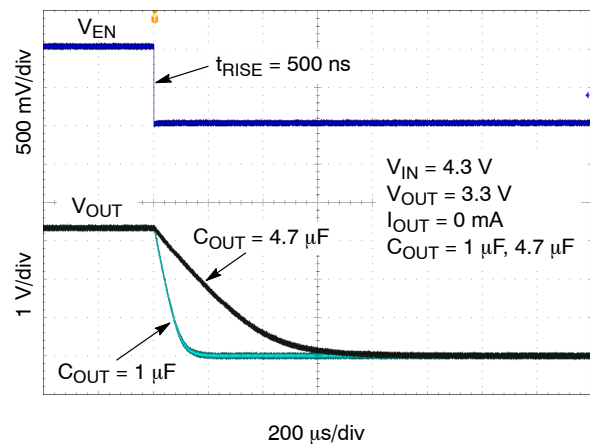


Figure 53. Enable Turn-Off – $V_{OUT} = 3.3 \text{ V}$

TYPICAL CHARACTERISTICS

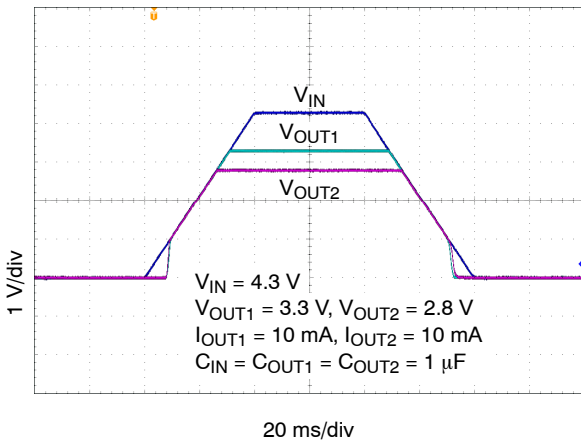
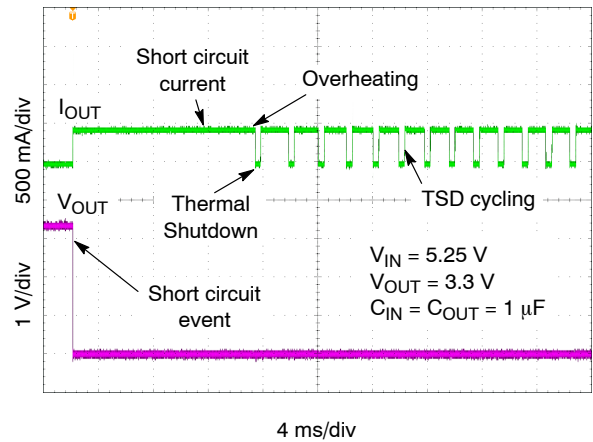
Figure 54. Turn-on/off – Slow Rising V_{IN} 

Figure 55. Short Circuit and Thermal Shutdown

General

The NCP154 is a dual output high performance 300 mA Low Dropout Linear Regulator. This device delivers very high PSRR (75 dB at 1 kHz) and excellent dynamic performance as load/line transients. In connection with low quiescent current this device is very suitable for various battery powered applications such as tablets, cellular phones, wireless and many others. Each output is fully protected in case of output overload, output short circuit condition and overheating, assuring a very robust design. The NCP154 device is housed in XDFN-8 1.6 mm x 1.2 mm package which is useful for space constrained application.

Input Capacitor Selection (C_{IN})

It is recommended to connect at least a 1 µF Ceramic X5R or X7R capacitor as close as possible to the IN pin of the device. This capacitor will provide a low impedance path for unwanted AC signals or noise modulated onto constant input voltage. There is no requirement for the min. or max. ESR of the input capacitor but it is recommended to use ceramic capacitors for their low ESR and ESL. A good input capacitor will limit the influence of input trace inductance and source resistance during sudden load current changes. Larger input capacitor may be necessary if fast and large load transients are encountered in the application.

Output Decoupling (C_{OUT})

The NCP154 requires an output capacitor for each output connected as close as possible to the output pin of the regulator. The recommended capacitor value is 1 µF and X7R or X5R dielectric due to its low capacitance variations over the specified temperature range. The NCP154 is designed to remain stable with minimum effective capacitance of 0.33 µF to account for changes with temperature, DC bias and package size. Especially for small package size capacitors such as 0201 the effective capacitance drops rapidly with the applied DC bias.

There is no requirement for the minimum value of Equivalent Series Resistance (ESR) for the C_{OUT} but the maximum value of ESR should be less than 3 Ω. Larger output capacitors and lower ESR could improve the load transient response or high frequency PSRR. It is not recommended to use tantalum capacitors on the output due to their large ESR. The equivalent series resistance of tantalum capacitors is also strongly dependent on the temperature, increasing at low temperature.

Enable Operation

The NCP154 uses the dedicated EN pin for each output channel. This feature allows driving outputs separately.

If the EN pin voltage is <0.4 V the device is guaranteed to be disabled. The pass transistor is turned-off so that there is virtually no current flow between the IN and OUT. The active discharge transistor is active so that the output voltage V_{OUT} is pulled to GND through a 50 Ω resistor. In the disable state the device consumes as low as typ. 10 nA from the V_{IN}.

If the EN pin voltage >0.9 V the device is guaranteed to be enabled. The NCP154 regulates the output voltage and the active discharge transistor is turned-off.

The both EN pin has internal pull-down current source with typ. value of 300 nA which assures that the device is turned-off when the EN pin is not connected. In the case where the EN function isn't required the EN should be tied directly to IN.

Output Current Limit

Output Current is internally limited within the IC to a typical 400 mA. The NCP154 will source this amount of current measured with a voltage drops on the 90% of the nominal V_{OUT}. If the Output Voltage is directly shorted to ground (V_{OUT} = 0 V), the short circuit protection will limit the output current to 520 mA (typ). The current limit and short circuit protection will work properly over whole temperature range and also input voltage range. There is no limitation for the short circuit duration. This protection works separately for each channel. Short circuit on the one channel do not influence second channel which will work according to specification.

Thermal Shutdown

When the die temperature exceeds the Thermal Shutdown threshold (T_{SD} – 160°C typical), Thermal Shutdown event is detected and the affected channel is turn-off. Second channel still working. The channel which is overheated will remain in this state until the die temperature decreases below the Thermal Shutdown Reset threshold (T_{SDU} – 140°C typical). Once the device temperature falls below the 140°C the appropriate channel is enabled again. The thermal shutdown feature provides the protection from a catastrophic device failure due to accidental overheating. This protection is not intended to be used as a substitute for proper heat sinking. The long duration of the short circuit condition to some output channel could cause turn-off other output when heat sinking is not enough and temperature of the other output reach T_{SD} temperature.

Power Dissipation

As power dissipated in the NCP154 increases, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material, and the ambient temperature affect the rate of junction temperature rise for the part.

The maximum power dissipation the NCP154 can handle is given by:

$$P_{D(MAX)} = \frac{[125^{\circ}\text{C} - T_A]}{\theta_{JA}} \quad (\text{eq. 1})$$

The power dissipated by the NCP154 for given application conditions can be calculated from the following equations:

$$P_D \approx (V_{IN1} \cdot I_{GND1}) + (V_{IN2} \cdot I_{GND2}) + I_{OUT1}(V_{IN1} - V_{OUT1}) + I_{OUT2}(V_{IN2} - V_{OUT2}) \quad (\text{eq. 2})$$

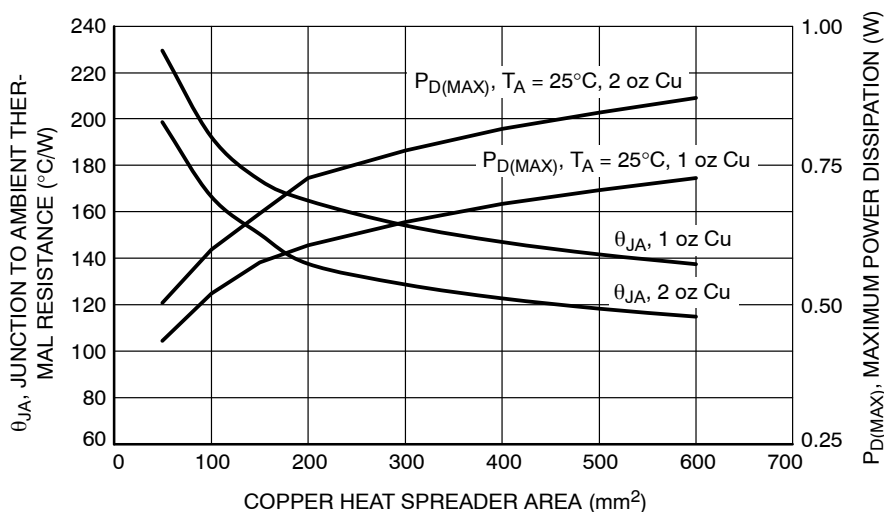


Figure 56. θ_{JA} vs. Copper Area (XDFN-8)

Reverse Current

The PMOS pass transistor has an inherent body diode which will be forward biased in the case that $V_{OUT} > V_{IN}$. Due to this fact in cases, where the extended reverse current condition can be anticipated the device may require additional external protection.

Power Supply Rejection Ratio

The NCP154 features very good Power Supply Rejection ratio. If desired the PSRR at higher frequencies in the range 100 kHz – 10 MHz can be tuned by the selection of C_{OUT} capacitor and proper PCB layout.

Turn-On Time

The turn-on time is defined as the time period from EN assertion to the point in which V_{OUT} will reach 98% of its nominal value. This time is dependent on various application conditions such as $V_{OUT(NOM)}$, C_{OUT} , T_A .

PCB Layout Recommendations

To obtain good transient performance and good regulation characteristics place input and output capacitors close to the device pins and make the PCB traces wide. In order to minimize the solution size, use 0402 capacitors. Larger copper area connected to the pins will also improve the device thermal resistance. The actual power dissipation can be calculated from the equation above (Equation 2). Expose pad should be tied the shortest path to the GND pin.

NCP154

Table 5. ORDERING INFORMATION

Device	Voltage Option* (OUT1/OUT2)	Marking	Package	Shipping
NCP154MX280280TAG (Note 7)	2.8 V / 2.8 V	DA	XDFN-8 (Pb-Free)	3000 or 5000 / Tape & Reel (Note 7)
NCP154MX180280TAG	1.8 V / 2.8 V	DC		3000 / Tape & Reel
NCP154MX330180TAG	3.3 V / 1.8 V	DD		
NCP154MX300180TAG	3.0 V / 1.8 V	DE		
NCP154MX330280TAG (Note 7)	3.3 V / 2.8 V	DF		3000 or 5000 / Tape & Reel (Note 7)
NCP154MX330330TAG	3.3 V / 3.3 V	DG		3000 / Tape & Reel
NCP154MX330300TAG (Note 7)	3.3 V / 3.0 V	DH		3000 or 5000 / Tape & Reel (Note 7)
NCP154MX300300TAG	3.0 V / 3.0 V	DJ		3000 / Tape & Reel
NCP154MX100180TAG	1.0 V / 1.8 V	DK		
NCP154MX150280TAG (Note 7)	1.5 V / 2.8 V	DL		3000 or 5000 / Tape & Reel (Note 7)
NCP154MX180290TAG (Note 7)	1.8 V / 2.9 V	DM		
NCP154MX180300TAG	1.8 V / 3.0 V	DN		3000 / Tape & Reel
NCP154MX280270TAG (Note 7)	2.8 V / 2.7 V	DP		3000 or 5000 / Tape & Reel (Note 7)
NCP154MX310310TAG	3.1 V / 3.1 V	DQ		3000 / Tape & Reel
NCP154MX330285TAG (Note 7)	3.3 V / 2.85 V	DR		3000 or 5000 / Tape & Reel (Note 7)
NCP154MX180270TAG	1.8 V / 2.7 V	DT		3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).

*Contact factory for other voltage options. Output voltage range 1.0 V to 3.3 V with step 50 mV.

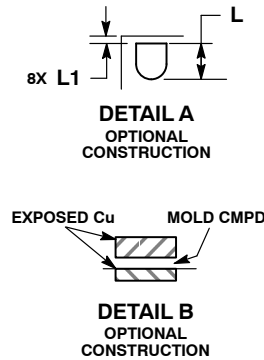
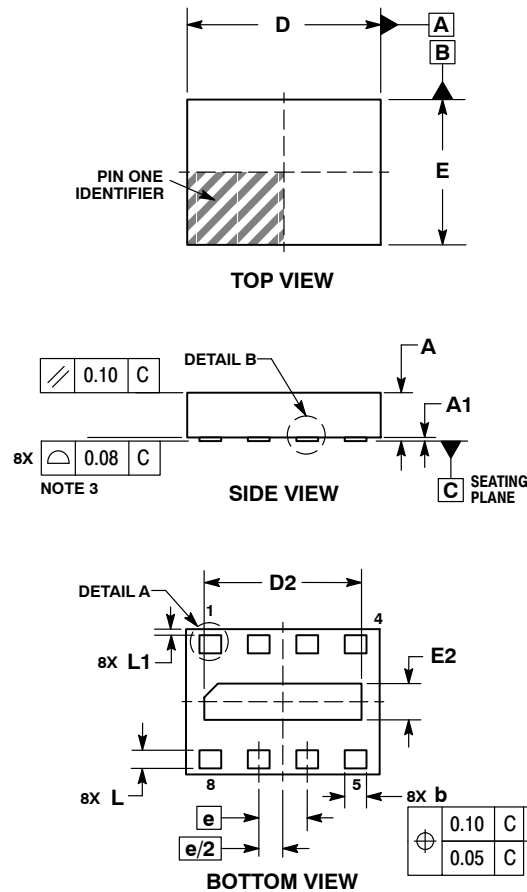
7. Product processed after October 1, 2022 are shipped with quantity 5000 units / Tape & Reel.



SCALE 4:1

XDFN8 1.6x1.2, 0.4P
CASE 711AS
ISSUE D

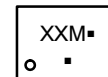
DATE 08 DEC 2015



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

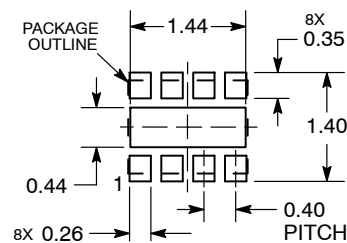
DIM	MILLIMETERS		
	MIN	NOM	MAX
A	0.300	0.375	0.450
A1	0.000	0.025	0.050
b	0.130	0.180	0.230
D	1.500	1.600	1.700
D2	1.200	1.300	1.400
E	1.100	1.200	1.300
E2	0.200	0.300	0.400
e	0.40 BSC		
L	0.150	0.200	0.250
L1	0.000	0.050	0.100

GENERIC MARKING DIAGRAM*


- XX = Specific Device Code
- M = Date Code
- = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

RECOMMENDED MOUNTING FOOTPRINT*


DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the [onsemi Soldering and Mounting Techniques Reference Manual](#), [SOLDERRM/D](#).

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